

Replaces December 1998 version, DS5100-3.0

MP02 XX 130 Series

Dual Diode Modules

DS5100- January 2000

FEATURES

- Dual Device Module
- Electrically Isolated Package
- Pressure Contact Construction
- International Standard Footprint
- Alumina (non-toxic) Isolation Medium

APPLICATIONS

- Rectifier Bridges
- DC Power Supplies
- Plating Rectifiers
- Traction Systems

VOLTAGE RATINGS

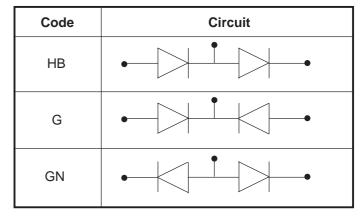
Type Number	Repetitive Peak Voltages V _{RRM}	Conditions
MP02/130 - 25	2500	T _{vj} = 150°C
MP02/130 - 22	2200	I _{RM} = 30mA
MP02/130 - 20	2000	$V_{RSM} = V_{RRM} + 100V$
MP02/130 - 18	1800	

Lower voltage grades available. For full description of part number see "Ordering Instructions" on page 3.

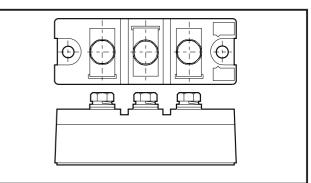
CURRENT RATINGS - PER ARM

KEY	PARAMETERS
V _{RRM}	2500V
I ESM	2200A
I _{F(AV)} (per arm)	130A
V	2500V
V_{isol}	250

CIRCUIT OPTIONS



PACKAGE OUTLINE



Module outline type code: MP02. See Package Details for further information

Symbol	Parameter	Conditions		Max.	Units
I _{F(AV)} Mean forward current			T _{case} = 75°C	130	А
		$T_{case} = 85^{\circ}C$	116	А	
	Mean forward current		T _{heatsink} = 75°C	114	А
			T _{heatsink} = 85°C	101	A
I _{F(RMS)}	RMS value	$T_{case} = 75^{\circ}C$		204	А

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SURGE RATINGS - PER ARM

Symbol	Parameter	Conditions		Max.	Units
I _{FSM}	Surge (non-repetitive) on-state current	10ms half sine; T _j = 150°C	V _R = 0	2200	A
			$V_{R} = 50\% V_{RRM}$	1760	А
124	I ² t I ² t for fusing	10ms half sine;	V _R = 0	24200	A ² s
11		T _j = 150°C	$V_{R} = 50\% V_{RRM}$	15490	A ² s

THERMAL & MECHANICAL RATINGS

Symbol	Parameter	Conditions	Max.	Units
	R _{th(j-c)} Thermal resistance - junction to case	dc	0.37	°C/W
R _{th(j-c)}		halfwave	0.38	°C/W
		3 phase	0.39	°C/W
R _{th(c-hs)}	Thermal resistance - case to heatsink per Diode	Mounting torque = 6Nm with mounting compound	0.07	°C/W
T _{vj}	Virtual junction temperature		150	°C
T _{sto}	Storage temperature range		-40 to 150	°C
V _{isol}	Isolation voltage	Commoned terminals to base plate AC RMS, 1min, 50Hz	2.5	kV

CHARACTERISTICS

Symbol	Parameter	Conditions	Max.	Units
V _{FM}	Forward voltage	At 300A , T _{case} = 25°C	1.53	V
I _{RM}	Peak reverse current	At V_{RRM} , $T_j = 150^{\circ}C$	30	mA
V _{TO}	Threshold voltage	At $T_{vj} = 150^{\circ}C$	1.10	V
r _T	On-state slope resistance	At $T_{vj} = 150^{\circ}C$	1.30	mΩ

ORDERING INSTRUCTIONS

Part number is made up as follows:

MP02 HB 130 - 22

- MP = Pressure contact module
- 02 = Outline type
- = Circuit configuration code (see "circuit options" front page) HΒ
- = Nominal average current rating at $T_{case} = 75^{\circ}C$ 130
- 22 $= V_{RRM} / 100$

Examples:

MP02HB130 - 20 MP02G130 - 25 MP02GN130 - 18

Note: Prefered type is HB configuration. G and GN types are available for specific applications, only when requested.

MOUNTING RECOMMENDATIONS

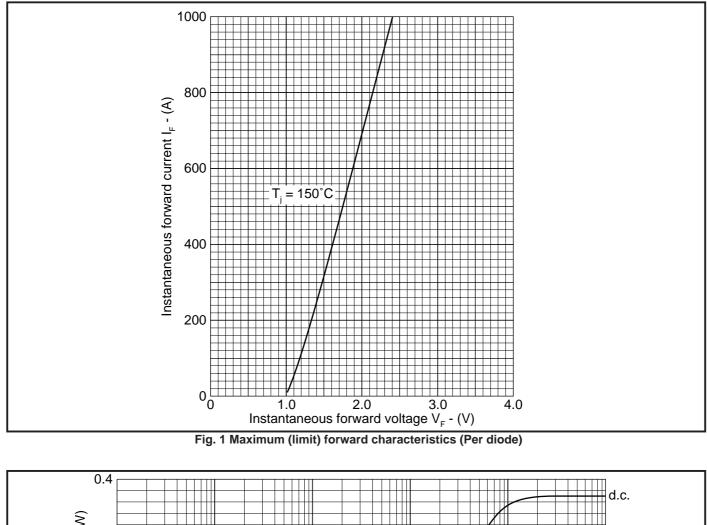
- Adequate heatsinking is required to maintain the base An even coating of thermal compound (eg. Unial) should be temperature at 75°C if full rated current is to be achieved. Power dissipation may be calculated by use of $V_{_{\rm TO}}$ and $r_{_{\rm T}}$ information in accordance with standard formulae. We can provide assistance with calculations or choice of heatsink if required.
- The heatsink surface must be smooth and flat; a surface finish of N6 (32µin) and a flatness within 0.05mm (0.002") are recommended.
- Immediately prior to mounting, the heatsink surface should be lightly scrubbed with fine emery, Scotch Brite or a mild chemical etchant and then cleaned with a solvent to remove oxide build up and foreign material. Care should be taken to ensure no foreign particles remain.

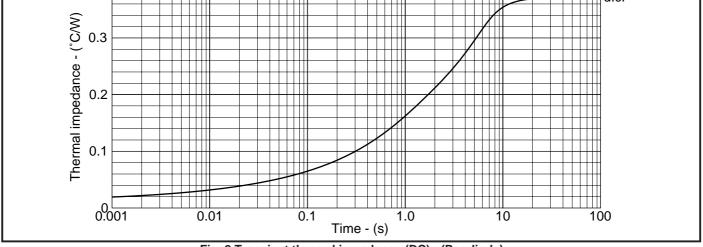
- applied to both the heatsink and module mounting surfaces. This should ideally be 0.05mm (0.002") per surface to ensure optimum thermal performance.
- After application of thermal compound, place the module squarely over the mounting holes, (or 'T' slots) in the heatsink. Using a torque wrench, slowly tighten the recommended fixing bolts at each end, rotating each in turn no more than 1/4 of a revolution at a time. Continue until the required torque of 6Nm (55lb.ins) is reached at both ends.

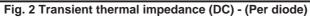
It is not acceptable to fully tighten one fixing bolt before starting to tighten the other. Such action may DAMAGE the module.

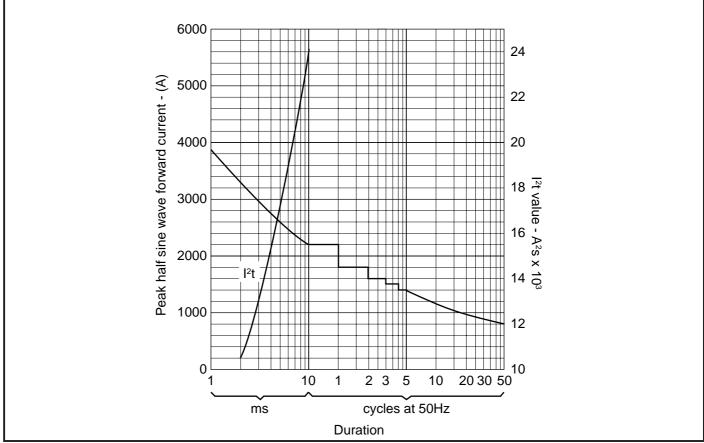
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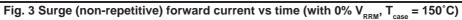
CURVES











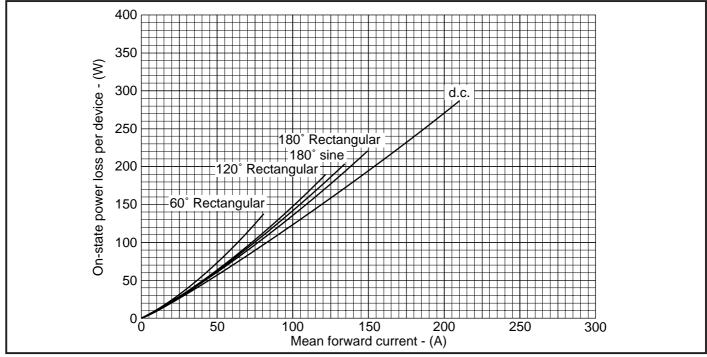
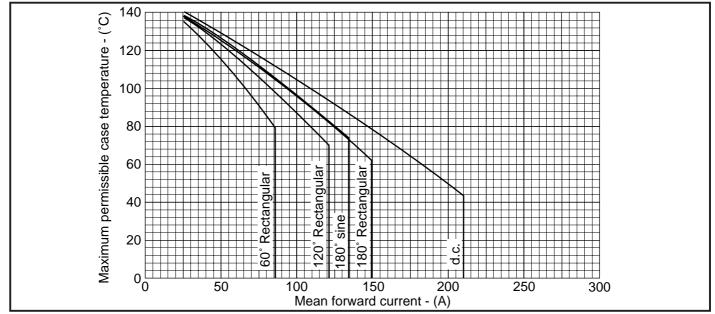
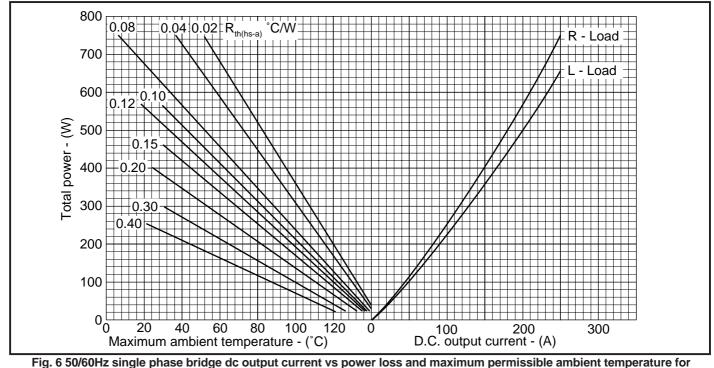


Fig. 4 On-state power loss per arm vs forward current at various conduction angles, 50/60Hz

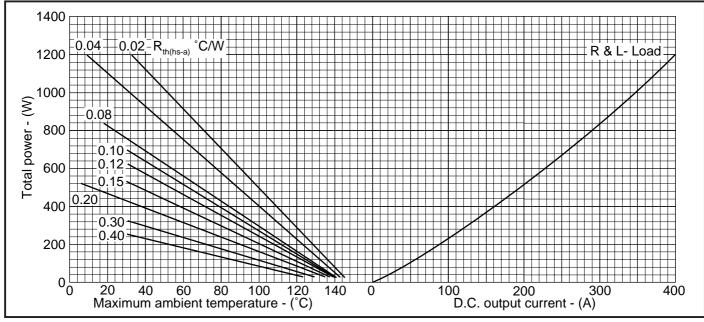


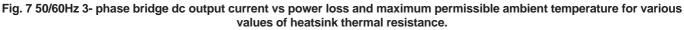




various values of heatsink thermal resistance.

(Note: R_{th(hs-a)} values given above are true heatsink thermal resistances to ambient and already account for R_{th(c-hs)} module contact thermal).



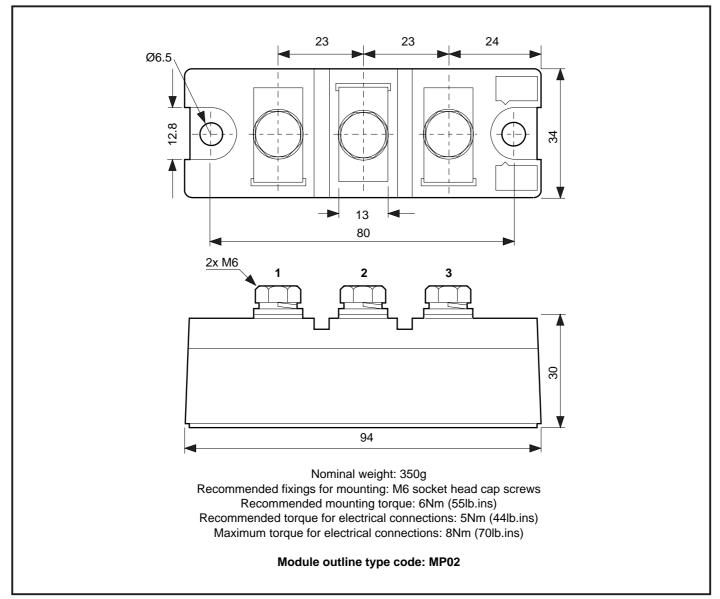


(Note: R_{th(hsa)} values given above are true heatsink thermal resistances to ambient and already account for R_{th(chs)} module contact thermal).

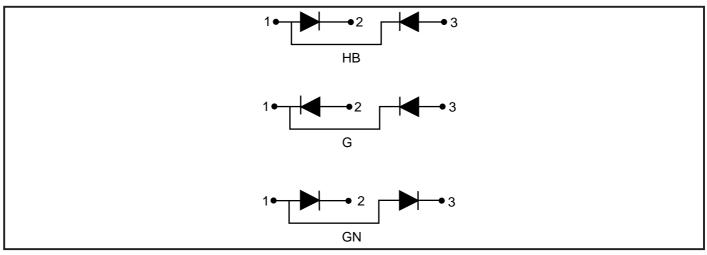
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PACKAGE DETAILS

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



CIRCUIT CONFIGURATIONS



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